WHAT IS CLAIMED IS:

- 1. An accessed object having a non-contact IC module including a semiconductor device and a radio communication antenna, wherein one of said radio communication antenna includes an IC module formed extending over two side of said accessed object.
- 2. An accessed object according to Claim 1, wherein said semiconductor device and said radio communication antenna are formed on a flexible sheet and said sheet is bent and attached to said accessed object.
- 3. An accessed object according to Claim 2, wherein a semiconductor device is provided in that position of said sheet which is away from the bent portion thereof.
- 4. An accessed object according to Claim 1, wherein said radio communication antenna is provided in the vicinity of a corner portion of the said accessed object.
- 5. Accessed body according to Claim 1, wherein said accessed object has a casing and said radio communication antenna is provided inside said casing.
- 6. An accessed object according to Claim 5, wherein said casing is opaque or translucent.
- 7. An accessed object according to Claim 1, wherein said accessed object is an information recording medium.
- 8. An accessed object having a non-contact IC

module including a semiconductor and a module-side antenna, wherein said module-side antenna has a first module-side antenna and a second module-side antenna continuous to said first module-side antenna, wherein said first module-side antenna secures an antenna effective area by coming face-to-face relation with a first apparatus-side in a first usage mode of communication apparatus to communicate with said accessed object, and wherein said second module-side antenna is disposed close to a second apparatus-side antenna in an access direction different from the access direction of said apparatus-side antenna in a second usage mode of the communication apparatus.

- 9. An accessed object according to Claim 1, wherein an insertion recess is provided in a specified position of said accessed object and said non-contact IC module is inserted into said insertion recess.
- 10. An accessed object according to Claim 2, wherein An accessed object according to Claim 2, wherein said insertion recess is a slit.
- 11. An accessed object according to Claim 2, wherein erroneous insertion preventive measure is provided both at said insertion recess and said non-contact IC module.
- 12. An accessed object according to Claim 1, wherein said non-contact IC module uses a printed circuit board, said first module-side antenna is provided on one surface of said printed circuit board,

said second module-side antenna is provided on the reverse surface of said printed circuit board and the first module-side antenna is continuous to the second module-side antenna via a through-hole.

- 13. An accessed object according to Claim 1, wherein said non-contact IC module uses a printed circuit board, said first module-side antenna and one part of said second module-side antenna are provided on one surface of said printed circuit board, the other part of said second module-side antenna is provided on the other part of said printed circuit board, and the one part of said second module-side antenna on the one surface of said printed circuit board is continuous to the other part of said second module-side antenna on the other part of said second module-side antenna on the other surface thereof.
- 14. An accessed object according to Claim 1, wherein said accessed object is an information recording medium.